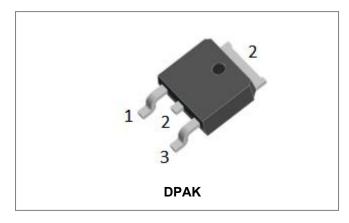






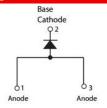
## MBRD350/MBRD360 SCHOTTKY RECTIFIER



#### **Features**

- 150℃ T<sub>J</sub> operation
- Center tap configuration
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- "-A" is an AEC-Q101 qualified device
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

#### **Circuit Diagram**



#### **Applications**

- Disk drives
- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection
- Battery charging

### **Maximum Ratings:**

Characteristics	Symbol	Condition		Max.	Units
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>	-	50	MBRD350	V
Working Peak Reverse Voltage DC Blocking Voltage	$V_{RWM}$		60	MBRD360	V
Average Rectified Forward Current	I <sub>F (AV)</sub>	50% duty cycle @Tc=125°C, rectangular wave form	3		Α
Peak One Cycle Non-Repetitive Surge Current	I <sub>FSM</sub>	8.3ms, Half Sine pulse	75		Α

#### **Electrical Characteristics:**

Characteristics	Symbol	Condition	Тур.	Max.	Units
Forward Voltage Drop*	V <sub>F1</sub>	@ 3A, Pulse, T <sub>J</sub> = 25 °C @ 6A, Pulse, T <sub>J</sub> = 25 °C	0.55 0.65	0.60 0.70	V
	V <sub>F2</sub>	@ 3A, Pulse, T <sub>J</sub> = 125 °C @ 6A, Pulse, T <sub>J</sub> = 125 °C	0.48 0.60	0.45 0.625	٧
Reverse Current *	I <sub>R1</sub>	@V <sub>R</sub> = rated V <sub>R</sub> , T <sub>J</sub> = 25 °C	0.01	0.2	mA
	I <sub>R2</sub>	@V <sub>R</sub> = rated V <sub>R</sub> , T <sub>J</sub> = 125 °C	2	20	mA
Junction Capacitance	Ст	@ $V_R$ = 5.0 $V$ , $T_C$ = 25 ° $C$ $f_{SIG}$ = 1MHz	130	300	pF

<sup>\*</sup> Pulse width < 300  $\mu$ s, duty cycle < 2%

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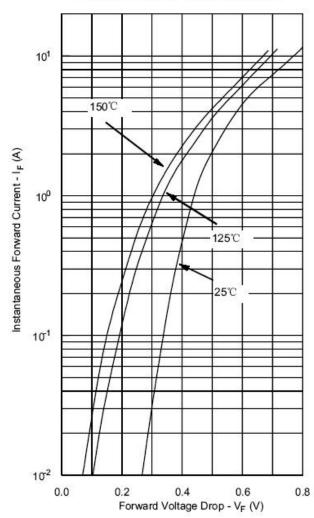


### **Thermal-Mechanical Specifications:**

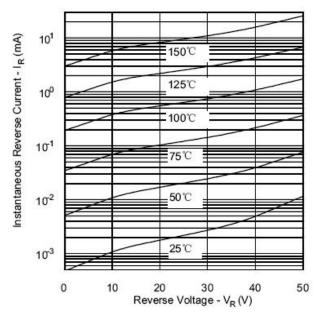
Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +150	°C
Storage Temperature	T <sub>stg</sub>	-	-55 to +150	°C
Typical Thermal Resistance Junction to Case	R <sub>θ</sub> JC	-	6	°C/W
Approximate Weight	wt	-	0.39	g
Case Style	DPAK			

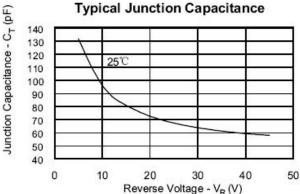
# **Ratings and Characteristics Curves**

### **Typical Forward Characteristics**



### Typical Reverse Characteristics





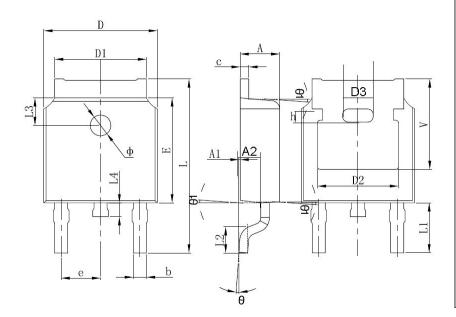
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### **Mechanical Dimensions DPAK**



SYMBOL	Millimeters		Inches	
STIVIBUL	Min.	Max.	Min.	Max.
Α	2.20	2.40	0.087	0.094
A1	0.00	0.127	0.000	0.005
b	0.66	0.86	0.026	0.034
С	0.46	0.60	0.018	0.024
D	6.50	6.70	0.256	0.264
D1	5.13	5.46	0.202	0.215
D2	4.83	REF.	0.190 REF.	
Е	6.00	6.20	0.236	0.244
е	2.186	2.386	0.086	0.094
L	9.70	10.40	0.381	0.409
L1	2.90 REF.		0.144 REF.	
L2	1.40	1.70	0.055	0.067
L3	1.60 REF.		0.063 REF.	
L4	0.60	1.00	0.024	0.039
Ф	1.10	1.30	0.043	0.051
Θ	0°	8°	0°	8°
h	0.00	0.30	0.000	0.012
V	5.35 REF.		0.211	REF.

### **Ordering Information**

Device	Package	Shipping
MBRD350	DPAK (Pb-Free)	2500pcs / reel
MBRD350TR	DPAK (Pb-Free)	2500pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

## **Marking Diagram**



Where XXXXX is YYWWL

 MBRD350
 = Part Name

 SSG
 = SSG

 YY
 = Year

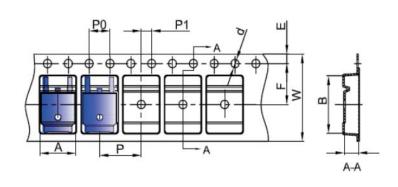
 WW
 = Week

 L
 = Lot Number

Cautions: Molding resin

Epoxy resin UL:94V-0

### **Carrier Tape Specification DPAK**



SYMBOL	Millimeters		
O T M DO L	Min.	Max.	
Α	6.80	7.00	
В	10.40	10.60	
С	2.60	2.80	
d	Ф1.45	Ф1.65	
E	1.65	1.85	
F	7.40	7.60	
P0	3.90	4.10	
Р	7.90	8.10	
P1	1.90	2.10	
W	15.90	16.30	

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